# DATASHEE

FRONT VIEW

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HATTELAND TECHNOLOGY an EMBRON Company 🕼

Manufacturer: Product: Type:

### **Compact Fanless Computer**

Hatteland Technology AS

Description:

### HTB40K-xx-DC yzzzzz (Short Depth model)

(where xx=CPU type, y=manufacturing site, z=configuration)

Last Revised: Revision#:

09 Dec 2024 03

## **Compact Fanless Computer**

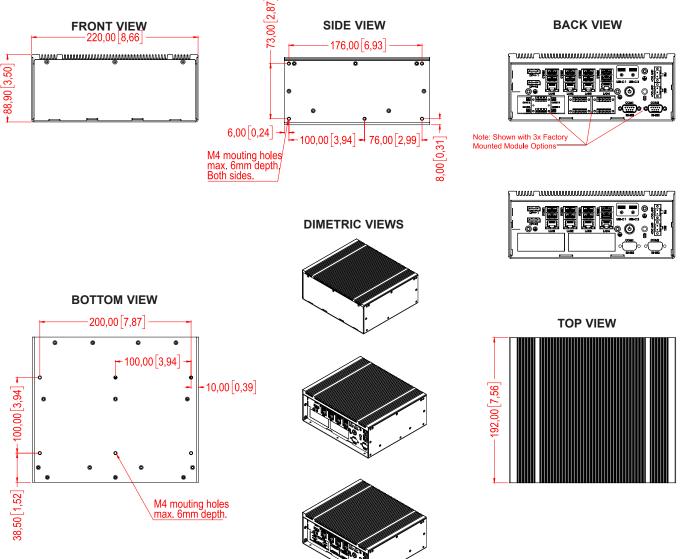
#### **Overview:**

The HTB40 range is based on the latest Intel chipset and Alderlake processor platform, delivering even more power for maritime technology developers to design and build high-end vessel control and monitoring solutions that enable safer and more effecient maritime operations.

HTB40 computers are available in two new form factors, short depth and long depth, allowing for flexible installation options including 3U rack mounting in pairs. Using the same system architecture as our new, second generation Series X Panel Computers, the HTB40 range offers significant processing speed and graphical performance improvements, which when combined with multiple-drive solid state storage and silent, fanless operation, positioning it among the most advanced computing platforms for maritime applications.

HTB40 computers can be delivered with a choice of Intel® Core™ / Celeron® processors, up to i7. Graphical output is handled by 2 x Display Port 1.4a and 2x USB-C ALT mode. While standard interfaces include 4 x Ethernet Ports, 2 x USB-C, 6 x USB2.0 and 2 x USB3.2. The HTB40 platform also supports a wide range of interface modules such as CAN/NMEA COM/COM and DIO, ensuring it is ready off-theshelf for all maritime applications. In addition, HTB40 range of computers features a lightweight, fully enclosed aluminium chassis and comes with dual DC inputs.

**BACK VIEW** 



SIDE VIEW

Dimensions might be shown with or without decimals and indicated as mm [inches]. Tolerance on drawings is +/- 1mm. For accurate measurements, check relevant DWG file.

## SPECIFICATIONS

Note: All specifications are subject to change without prior notice! Please visit www.hattelandtechnology.com for the latest electronic version.



TECHNICAL DESCRIPTION

#### -: Chandrand -

Computer Specifications: (Standard model)		External Connector Type
Operating System     Processor     Memory/RAM     Storage internal     Graphics     Graphics Res.     System Chipset	<ul> <li>None or Customized image - See table below</li> <li>1 x Intel® Core™ - See table below</li> <li>2 x SO-DIMM SLOT DDR5-4800, Max 2x32GB - See table below</li> <li>1 x 2.5" SSD</li> <li>Intel® Iris® Xe Graphics eligible OpenGL 4.6, DirectX 12.1, OpenCL 3.0 4 independent displays (valid combinations: ref Intel datasheet)</li> <li>DP = 7680 x 4320 @ 60Hz Max</li> <li>Integrated in 12th Generation Intel® Core™ U-series processor</li> </ul>	2 x DP++ 1.4a
<ul> <li>BIOS</li> <li>Ethernet #1</li> <li>Ethernet #2</li> <li>Ethernet #3</li> <li>Ethernet #4</li> <li>USB Ports #1</li> <li>USB Ports #3</li> <li>Power Manager</li> <li>Watchdog Timer</li> </ul>	: ACPI support : 1 x 10/100/1000Mbps, Realtek RTL8119I Gigabit LAN : 1 x 10/100/1000Mbps, Realtek 8119I Gigabit LAN : 1 x 10/100/1000Mbps, Intel® i226IT Gigabit LAN : 1 x 10/100/1000Mbps, Intel® i219V LAN : 6 x USB2.0 (<5m) : 2 x USB3.2 (<3m) : 2 x USB3.2 (<3m) DP1.4a ALT mode : ACPI S3/S4 : 256 Segments, 0, 1, 2255 sec/min	1 x RJ-45, Teaming 1 x RJ-45, Teaming 1 x RJ-45, Teaming 1 x RJ-45, Teaming 6 x USB Type A 2 x USB Type A 2 x USB-C
<ul> <li>RTC</li> <li>H/W Status Mont.</li> <li>Battery</li> </ul>	: 0.5s/day** : TPM2.0, Firmware Raid, Temperatures, voltages, Battery load status Alarm, cooling far : Normal operational conditions: life time >5 year, worst case conditions(@70C, 24/7): applicable for system without CPU/system FAN.	

#### **Power Specifications:**

### **Power Supply options:**

Dual DC Input 24VDC, 24V nom, Galvanic isolated, automatic switch between power source
 Power Consumption\* - Operating : 52W TBD (typ)\* - 75W (max) - \*at 25% load. Max Allowed External USB load = 10W.

2 x 2-pin Terminal Block 5.08

#### Available Computer Configurations:

	Available compared comparations.			
Туре	Description	Size/Specification		
CPU		<ul> <li>- 3.5GHz / 4.7GHz @15W, Chipset: Intel® Iris® Xe Graphics eligible</li> <li>- 3.3GHz / 4.4GHz @15W, Chipset: Intel® Iris® Xe Graphics eligible</li> <li>- 3.3GHz / 4.4GHz @15W, Chipset: Intel® UHD Graphics for 12th Gen Intel®</li> <li>- 1.0 GHz @15W, Chipset: Intel® UHD Graphics for 12th Gen Intel®</li> </ul>		
Memory	Dual Channel, DDR5 SO-DIMM, 2 slots available	- 2x8GB (Standard), 2x16GB, 2x32GB (Max). 1x8 GB RAM (*Intel Iris Graphics requires 2x**GBRAM)		
Storage	1 x 2.5" SDD	- 240GB (599TBW),480GB (945TBW),960GB (1750TBW), 1.9TB (8.8PBW). Review "SSD Selection Guide" in User Manual		
OS Option 32/64bit where applicable	Windows 10 2021 IoT Enterprise LTSC - Product Distribution End Date January 2029. Windows 11 2024 IoT Enterprise LTSC. Linux Kernel xx TBD			
Factory Mounted Options: Available Accessories:				
<ul> <li>1 × HTA20200</li> <li>1 × HTA20200</li> <li>1 × PCA10025</li> <li>1 × PCA10025</li> <li>1 × VSD20313</li> <li>1 × VSD20313</li> <li>1 × PCA20005</li> <li>1 × PCA20082</li> <li>1 × P</li></ul>	200828-1 (4 x COM RS-422/485 isolated NMEA 4 channel) mod 202-SLCAN: Socket CAN isolated, 2 channel module* 202-SLCAN: Socket CAN isolated, 2 channel module* 201-1: (2W Amplified Audio out via DB9F)* - Pending EN60945 20309-1: Dual Isolated RS-232, 2xDB9M module* 201: LAN 1Gbps, 2 x SFP module* 201: LAN 1Gbps, 2 x SFP module* 201: LAN 1Gbps, 2 x SFP module* 20309-1: Dual Isolated RS-232, 2xDB9M module* 20309-1: Dual Isolate	<ul> <li>HT 00263 OPT-A1/B1: 4 x RS-232 COM non-isolated, USB ext. module</li> <li>HT 00264 OPT-A1/B1: 1 x CAN isolated, 2 channel, USB ext. module [1]</li> <li>HT 00264 OPT-A2/B2: 1 x SLCAN isolated, 2 channel, USB ext. module [1]</li> <li>HT 00273 OPT-A1/B1: 4 x Digital IN/OUT isolated, USB ext. module</li> <li>HT 00277 OPT-A1: 2 x LAN 10/100Mbps, RJ45, USB ext. module</li> <li>HT 00277 OPT-A1: 1 x Cable Retainer/Relief Kit**</li> <li>HT RET STD-A1: 1 x Cable Retainer/Relief Kit**</li> <li>HT RMK STD-A1: 1 x 2U Rack Mount Kit RAL9011</li> <li>HT SRK STD-A2: 1 x 3U 19" Slide Rack Mount Kit (For 1 or 2 x HTB40)</li> <li>SF-41-26: 2 x 20" ball bearing sliding rail kit for 19" Rack*</li> <li>JH CO1MF AA: 1 x USB Cable 1m, Type A to Chassis mount receptacle</li> <li>HT 0300 MSOS: OS options: https://www.hattelandtechnology.com/os</li> <li>HT D0300 MSOS: OS options: https://www.hattelandtechnology.com/os</li> </ul>		

<sup>[1]</sup> Note: Due to driver limitations, only 1 instance of this module can be connected to the same Computer/Panel Computer unit. If Computer/Panel Computer already has SLCAN functionality builtin, connecting this external module will always fail

#### MECHANICAL DESCRIPTION

#### **Physical Specifications:**

- W:220.00 [8.66"] x H:88.90 [3.50"] x D:192.00 [7.56"] mm [inch]
- Weight: 2.5 kg / 5.5lbs
- Aluminium Cooling Chassis
- Includes: Mounting Bracket Kit, USB + DP/HDMI Retainers, Cable Relief Retainer Power Button, Power LED, Activity LED SSD

\*Power Consumption: Numbers are specified as the unit is delivered from factory. All additional installed equipment like USB, PCIe and similar loads have to be added to power consumption. Note that total extra load have to be multiplied by 1.5 to compensate for efficiency in internal power converters. Typical power consumption varies a lot with computer load. We measure with 25% of max computer load.

#### **Environmental Considerations:**

<ul> <li>Operating</li> </ul>	: Temperature -15°C to +55°C
Storage	: Temperature -20°C to +60°C
Humidity	· Up to 95% (Operating / Storage)

- Shock Vibration
   Shock Vibration
- (Bonded)
- Compass Safe Distance : Standard: 30cm - Steering: 10cm

#### Lifetime Considerations:

Even though the test conditions for bridge units provide for a maximum operating temperature of 55°C, continuous operation of all electronic components should, if possible, take place at ambient temperatures of only 25°C. This is a necessary prerequisite for long life and low service costs.

#### CERTIFICA A P P R O V & ES S

IEC 60945 4th (EN 60945:2002)\* ClassNK - Nippon Kaiji Kyokai\*

EN55024\* IACS E10\* CCS - China Classification Society\*

These products have been tested / type approved by the following classification societies: EN55022, Class A\* ABS - American Bureau of Shipping\*

\*=pending EU RO MR - Mutual Recognition\* BV - Bureau Veritas\*